

LIMITED TENDER ENQUIRY

CORRIGENDUM/AMENDMENT No. I - Date: 24/02/2023

Tender No. : 089/MYS/MMD/2022-23 dated 08/02/2023

Tender Name: SUPPLY OF BUNDLING FOIL FOR BPSX9 AT BRBNMPL, MYSURU

The following contents of the Tender No. given above are amended as per details given below.

S. No.	Description	Original details as Per Tender	Revised details as per Amendment/ Corrigendum No. I dated 24/02/2023	Reference Page number of Tender
1.	Section VII: Technical Specifications	<u>Technical Specifications of BUNDLING FOIL FOR BPSX9:</u> Sr.No. I: Point No. 6 Card Board Core Inner Diameter: 76mm + 2mm, Card Board Length: 50mm	<u>Technical Specifications of BUNDLING FOIL FOR BPSX9:</u> Sr.No. I: Point No. 6 Card Board Core Inner Diameter: 76mm + 2mm, Card Board Length: 50mm and Card Board Core thickness must be 7mm +/-1 (Any kind of shape change/damage of core is not acceptable)	37
4.	<u>PART-A: COMPLIANCE STATEMENT- TECHNICAL</u>	<u>Sl.No. I: Point No. 6</u> Card Board Core Inner Diameter: 76mm + 2mm, Card Board Length: 50mm	<u>Sl.No. I: Point No. 6</u> Card Board Core Inner Diameter: 76mm + 2mm, Card Board Length: 50mm and Card Board Core thickness must be 7mm +/-1 (Any kind of shape change/damage of core is not acceptable)	38

Note: These changes are applicable to all other places of tender including Page No(s) given above.

All other terms and conditions remain unchanged.

This Corrigendum/Amendment forms part of the referred Tender. These pages of Corrigendum/Amendment are to be submitted along with Techno-Commercial Bid (Part – I) duly signed and sealed by authorised signatory.

Bidders who have already submitted their sealed offer have to submit the page of this Corrigendum/Amendment duly signed and sealed by authorised signatory within the closing date of submission.

For & on behalf of BRBNMPL,

General Manager - MMD
BRBNMPL, Note Mudran Nagar, Mysuru